## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Vitali Nesterenko	)
Serial No.:	10/531,553	)
Conf. No.:	3552	)
Filed:	May 2, 2006	)
For:	ISOSTATIC PRESSURE ASSISTED WAFER BONDING METHOD	) ) )
Art Unit:	2823	)
Examiner:	Stark, Jarrett J.	) )

## **RESPONSE C**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Final Office Action mailed March 5, 2009, please consider the following remarks: